

DTU



Agenda:

- **Nanofabrication in a time of Corona – a status**
- **UPS**
- **FFU**
- **Decomissioning of equipment**
- **Udvidelse af renrummet**
- **Cleanroom closures**



Nanolab's anti virus strategy continues:

- **Minimize infection risk**
- **Maximize throughput**
- **Avoid unnecessary administration**

General Corona rules apply

FACILITY UPDATE

Biometric authentication as a tool to simplify access to Nanolab

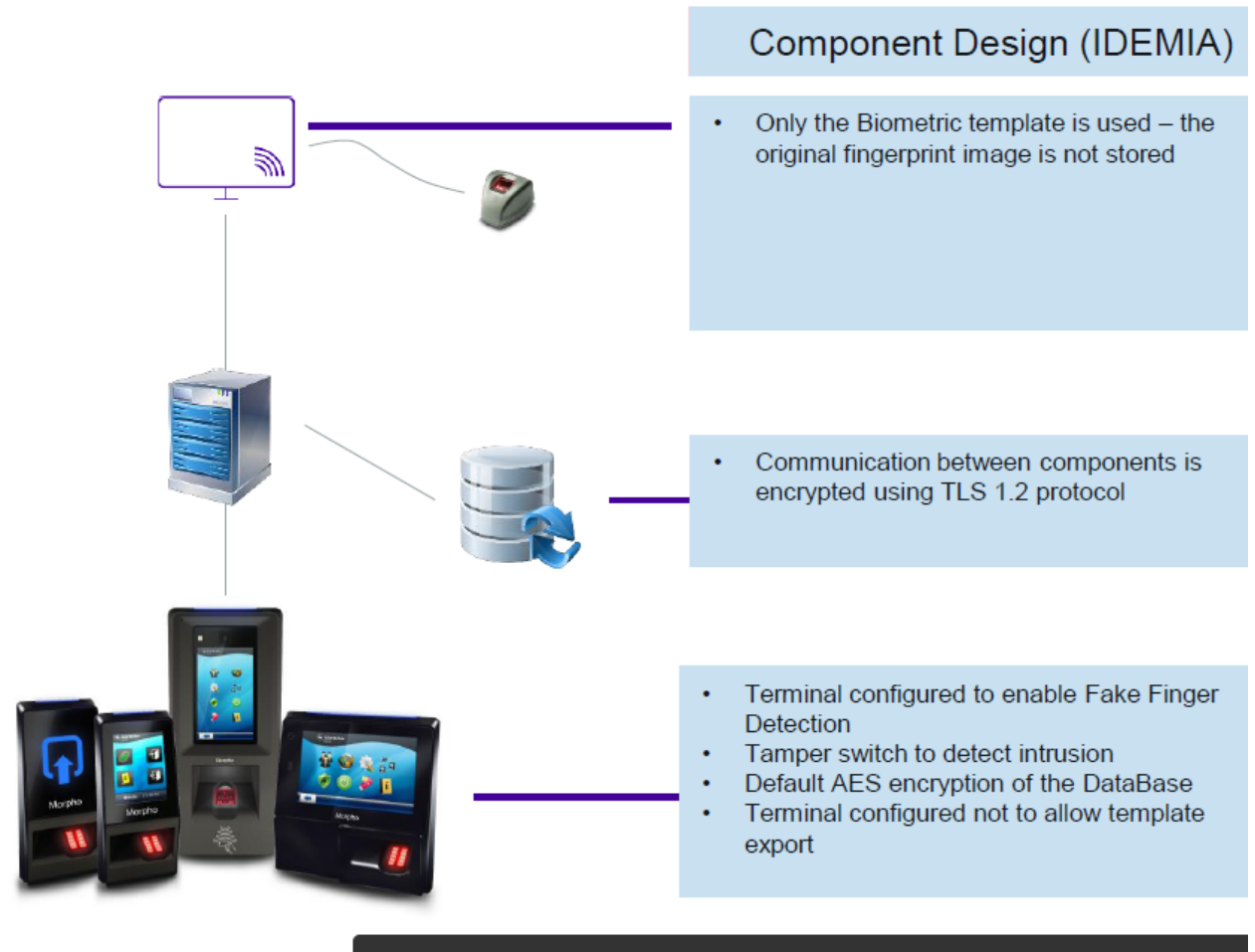
IDEMIA Morpho is our chosen solution.

Data will be handled according to DTUs GDPR procedures.

Until now: Packlab, chemical storage run on new terminals – Cleanroom will follow.

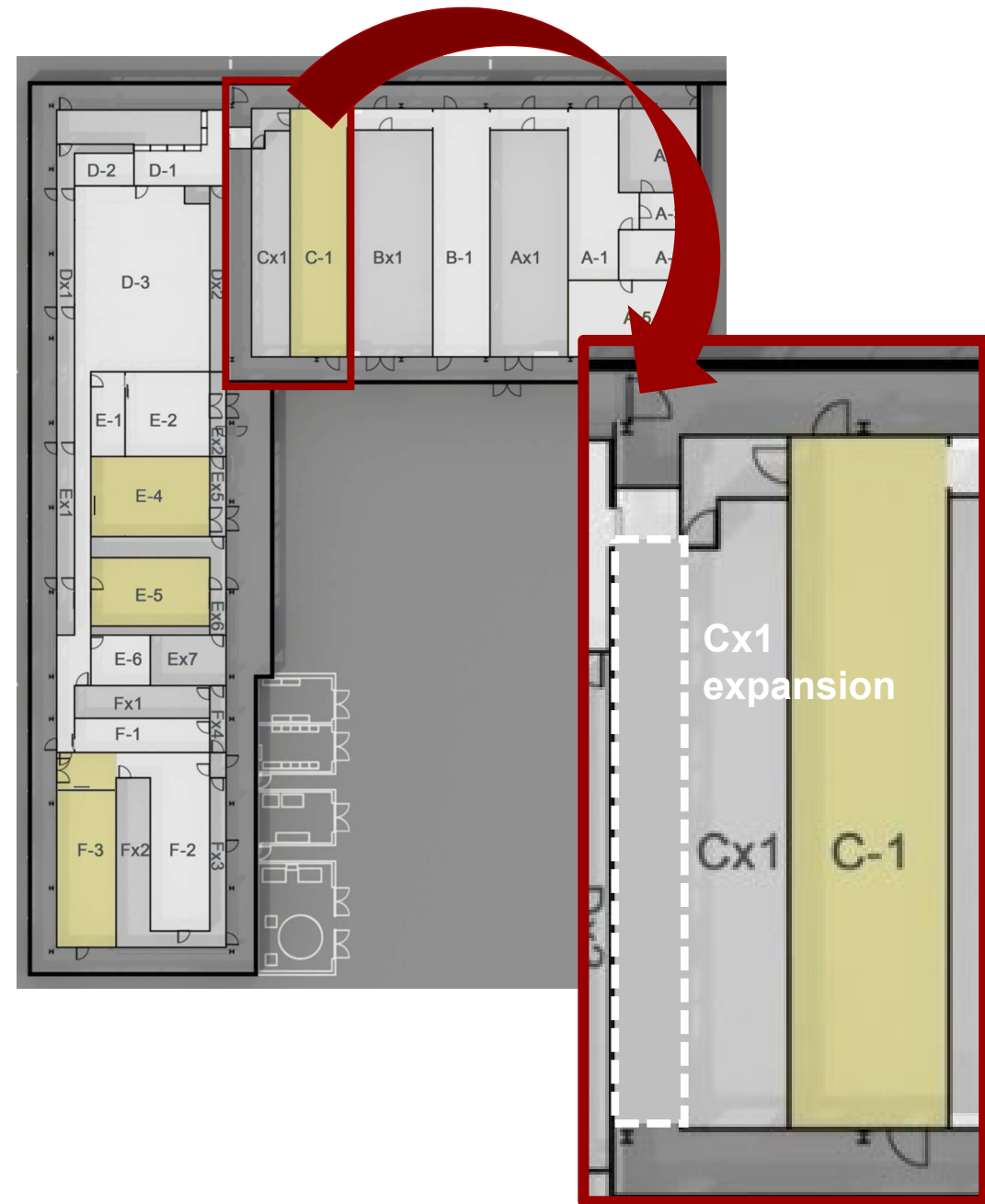
Terminals work with access cards at this point in time.

Responsible: Thøger thes@dtu.dk



Expansion of Cx1

- We need cleanroom space
- Including "dead end" in Cx1 can provide more service space
- Timeline
 - From 5 July to ca. September 2021
- Affected equipment
 - Probe station – new position inside cleanroom
 - Vacuum packer – new position inside cleanroom
 - BCB oven – new position inside cleanroom
 - Lifetime measurement – out of cleanroom
 - Inclined UV – might be moved



B346 UPS

- Entire B346 will be protected against power glitches < 2 min from end of 2021.
- Should minimize tool downtime

- B346 closed Saturday 26 June to Tuesday 29 June
 - Entire building is closed – including all labs
 - ALL power off in old cleanroom
 - All tools off in old cleanroom
 - Long tool recovery time expected



New electrical panels

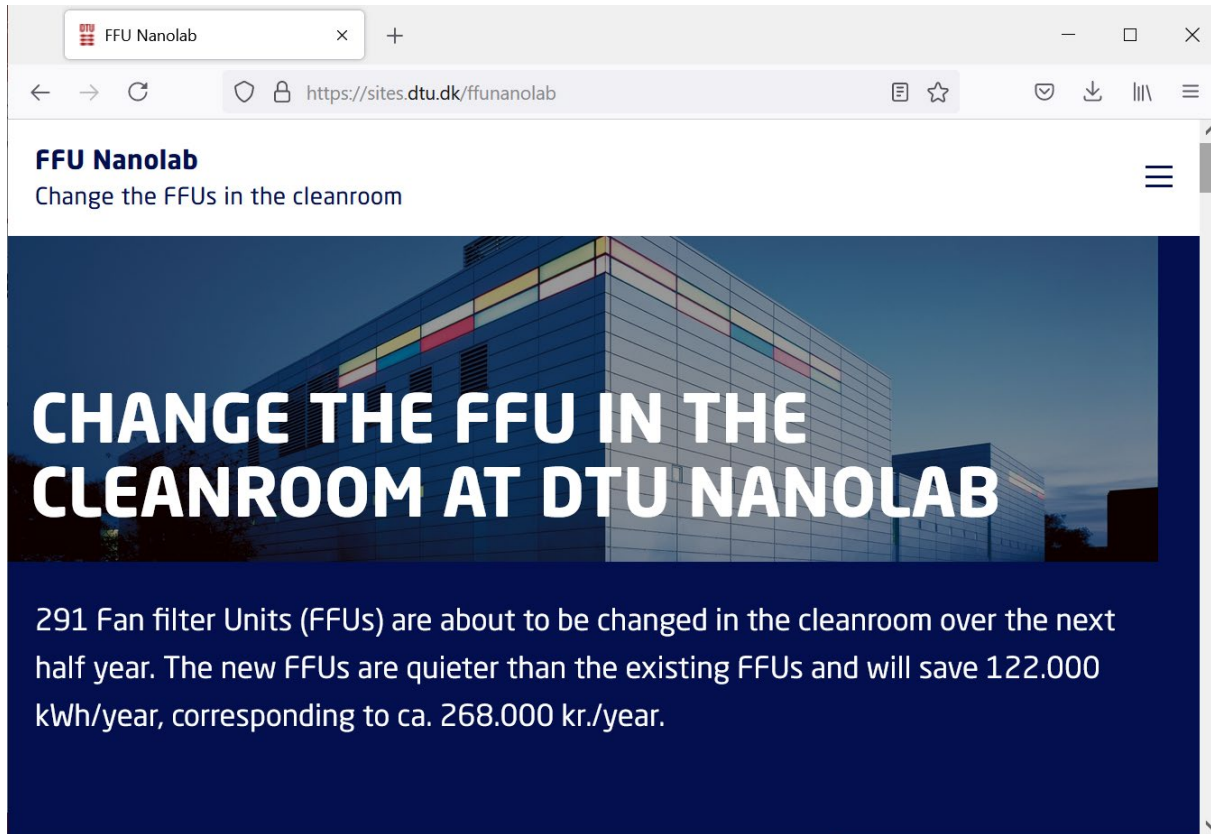
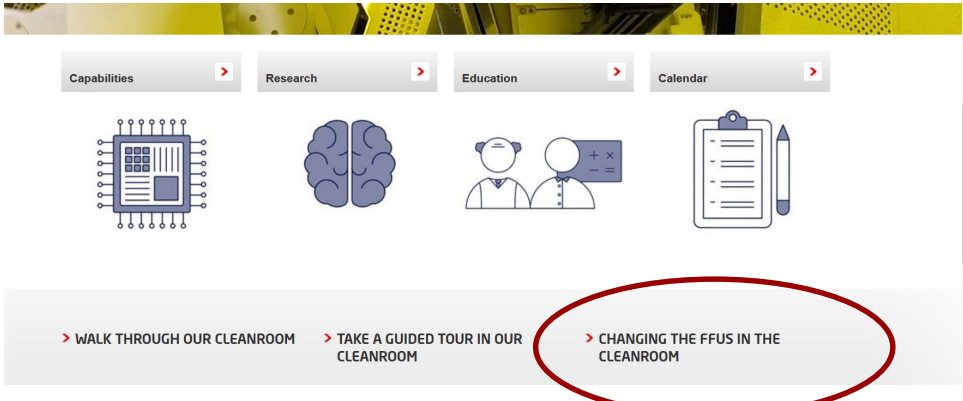
DTU FFU exchange

- Custom FFU
 - Ca. 53 dBA (lower than old FFUs)
 - Will save 122,000 kWh/yr
- Installation in E-1 (e-beam control room) complete
- Testing almost finished
- Gradual change from 8 August to 31 December 2021
- Only new parts of cleanroom (sections D, E and F)
- One room at a time
- Ca. 2-3 weeks per room
- **The biggest perturbation on cleanroom operations in many years**

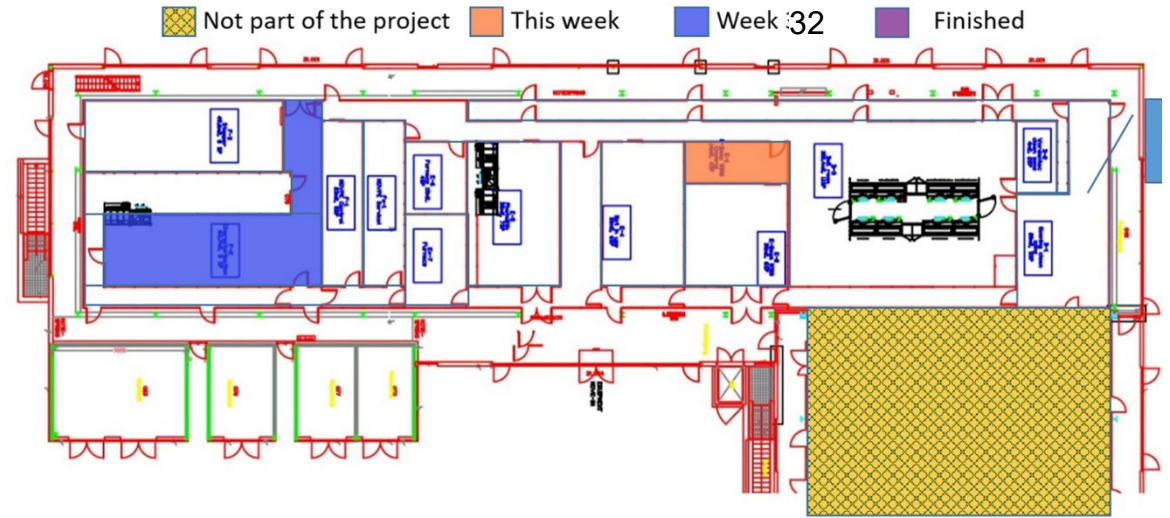


FFU exchange – Moving characterization tools out of F-2

- Why: To make space for FFU tools etc.
- What:
 - Sensofar
 - Tencor P-17
 - ...
- When: June to August 2021
- Where to: Relocates to C-1 and other cleanroom sections



FFU exchange information



Approximate time schedule

- F-2 (ALD room): Week 32-34
- F-1 (MOVPE room)
- F-3 (Stepper room)
- ...

EQUIPMENT



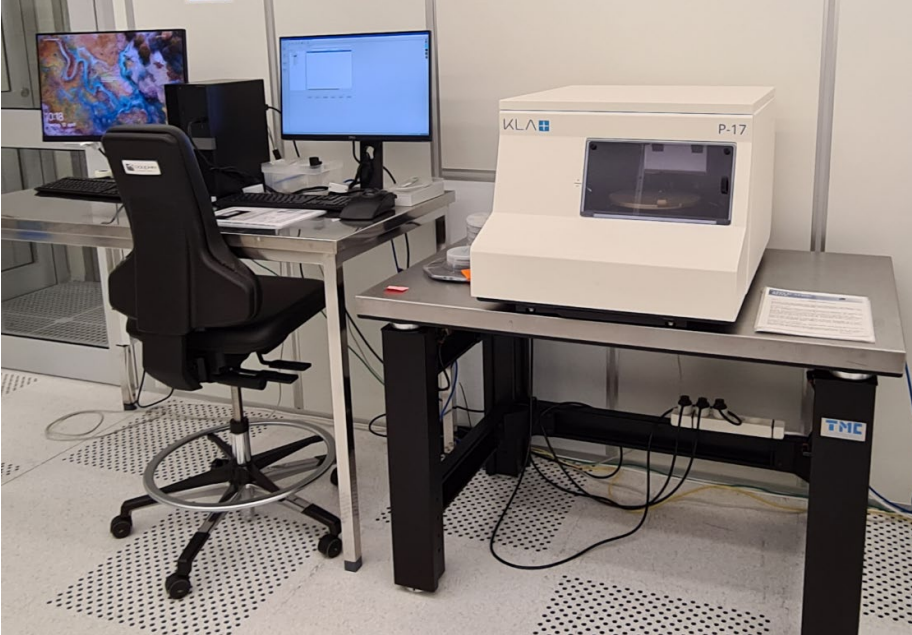
Dicing saw

- Dicer Disco DAD 3241 purchased
 - for wafers up to 200 mm
 - Silicon, Glass/quartz, ...
- Wafer cleaner Disco DCS 1441 (cleaning after dicing)
 - High pressure and Atomizing Nozzle water cleaning
- Various accessories
 - Tape mounter
 - UV tape release



- Install in Dicer room (346/157) in July– together with old dicer (tight space)
- Expected ready for use in Q3 2021

Tencor P-17, Dektak-8 replacement



Selected features

- 200 mm scan length without stitching ("true 8")
- Extended z-range: Dynamic range of 1000 μm
- 3D-stress mapping: multiple line scans (automatic rotation)
- Automatic measurement sequence
- Pattern recognition deskew alignment
- 3D map visualization

Please write to Thin Film (thinfilm@nanolab.dtu.dk) for questions

Standard RTP system: Jipelec JetFirst 200C (ECM)

Purpose/specs:

Replacing current Jipelec system

- Cold-wall system (water cooled stainless steel)
- Temp range: ambient to 1000 C (1200 C for 1 min)
- Temperature control: TC & Pyrometer
- 3 gas lines (MFCs) + purge line
- Dry pump (nXDS6i scroll)



Status: Installed in A-5 – accepted, process development on-going

(same room as present Jipelec-RTP)

CRAIC MSP 20/30 PV, advanced optical measurements



Selected features

MSP (MicroSpectroPhotometer)

Reflection/transmission/absorbance/polarization measurement

Wavelength range: 200 nm to 1700 nm

Minimum aperture size: 1.5 μm by 1.5 μm

Calibrated system with standards

Colormetric/mapping functions

Possibility for Raman/fluorescence/photoluminescence add-on

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200 mm Oxidation Furnace - retrofit

Purpose:

- Furnace tube for 200/150/100 mm dry-wet oxidation
- Retrofit in E-stack (one vacant slot)
- Process specs & qualification included (dry & wet)
- Expected ready Q1-2022



Transfer of processes: Physimeca=>Wordentec

Background:

Control system on **Physimeca** incl. hardware components

needs to be upgraded/replaced

- very costly & time consuming

Process transfer of "metal-stacks":

Physimeca => Wordentec

For now:

- Ni/Ge/Au
- Ti/Pt/Au
- Pd/Ge/Ti/Pt



Photoresist changes

- AZ resist production moves from Germany to Japan
 - AZ 5214E
 - AZ 4562
 - AZ MIR 701
- Merck: *"Performance is similar but not identical"*
- Nanolab test on AZ 5214E pilot batch:
 - Dose-to-clear almost identical (on MLA3)
 - Viscosity slightly different
- Etch selectivity etc. has not been tested
- *Spin Coater: Gamma e-beam & UV* will get new AZ 5214E resist.
- Users can then perform own tests
- No more old AZ 5214E in 4-5 months
- Awaiting test of AZ MIR 701



Tools leaving the cleanroom

- Black Magic (moves to B309)
- Physimeca (looking for replacement)
- Jipelec RTP (decommission after new Jipelec runs properly)
- C-1 fume hood
- Hardness tester (moves to basement)
- Sinton minority carrier lifetime measurement



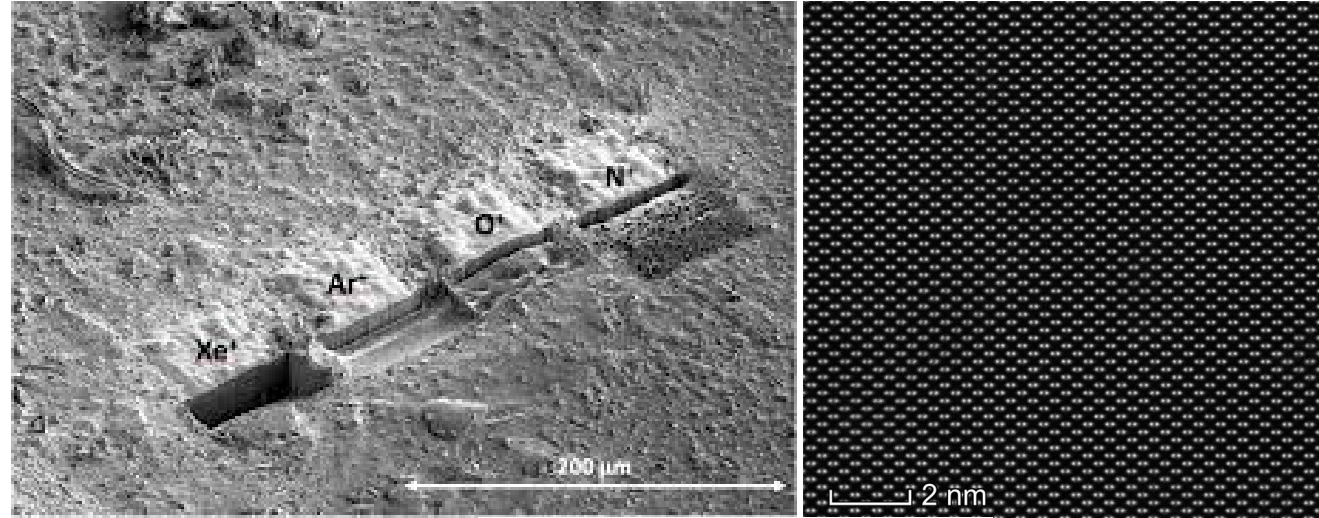
CHARACTERIZATION (307/314)

NEW Dual Beam Helios Hydra G5

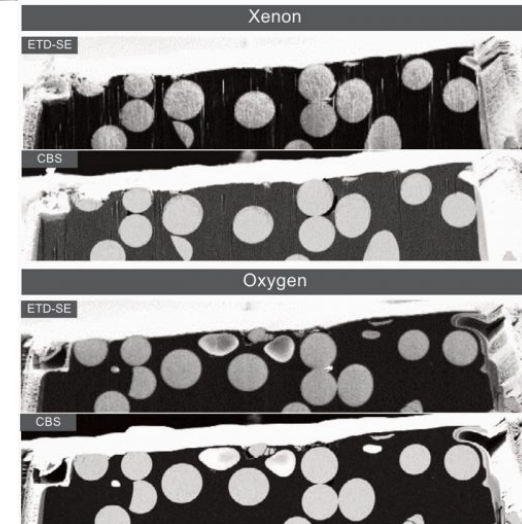
Purpose/specs:

Replacing current Helios G1

- Multi Gas Plasma FIB (Xe, N, O and AR)
- Automated TEM Lamella Prep
- Automated Atom Probe Tomography
- Monochromated E Beam for sub nm resolution down down to 500ev



Status: Instrument installed SAT begins next week (expected release October 2021)





B307 basement Soft Matter Lab Sketch

- Soft Matter lab for:
 - Sample preparation
 - Cryo SEM and TEM
 - No Cell Growth
- Key requirements include:
 - Temperature stability 1°C P-P/24hrs
 - Low vibration levels
- Lab area >100m²
- Awaiting reconstruction permission from building authorities

END OF PRESENTATION

- Running full capacity, restrictions confined to gowning
- Biometric access pilot
- New FIB SEM
- Several restructuring projects: soft matter lab, packlab
- **Major facility upgrades/replacements cause closures and inconveniences, FFU, UPS**